

# BAT54AWT1

Preferred Device

## Schottky Barrier Diodes

These Schottky barrier diodes are designed for high speed switching applications, circuit protection, and voltage clamping. Extremely low forward voltage reduces conduction loss. Miniature surface mount package is excellent for hand held and portable applications where space is limited.

### Features

- Extremely Fast Switching Speed
- Low Forward Voltage – 0.35 V (Typ) @  $I_F = 10 \text{ mAdc}$
- Pb-Free Packages are Available

### MAXIMUM RATINGS ( $T_J = 125^\circ\text{C}$ unless otherwise noted)

Rating	Symbol	Value	Unit
Reverse Voltage	$V_R$	30	V
Forward Power Dissipation @ $T_A = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_F$	200 1.6	mW mW/ $^\circ\text{C}$
Forward Current (DC)	$I_F$	200 Max	mA
Junction Temperature	$T_J$	-55 to 125	$^\circ\text{C}$
Storage Temperature Range	$T_{stg}$	-55 to +150	$^\circ\text{C}$

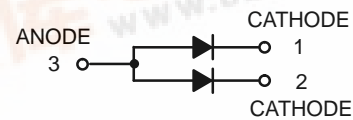
Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.



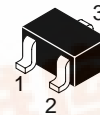
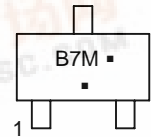
ON Semiconductor®

<http://onsemi.com>

### 30 VOLT SCHOTTKY BARRIER DETECTOR AND SWITCHING DIODES



### MARKING DIAGRAM

SOT-323  
CASE 419

B7 = Device Code  
M = Date Code\*  
▪ = Pb-Free Package

(Note: Microdot may be in either location)

\*Date Code orientation may vary depending upon manufacturing location.

### ORDERING INFORMATION

Device	Package	Shipping†
BAT54AWT1	SOT-323	3000/Tape & Reel
BAT54AWT1G	SOT-323 (Pb-Free)	3000/Tape & Reel
BAT54AWT3	SOT-323	10,000/Tape & Reel
BAT54AWT3G	SOT-323 (Pb-Free)	10,000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Preferred devices are recommended choices for future use and best overall value.



## BAT54AWT1

### ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ unless otherwise noted) (EACH DIODE)

Characteristic	Symbol	Min	Typ	Max	Unit
Reverse Breakdown Voltage ( $I_R = 10\ \mu\text{A}$ )	$V_{(BR)R}$	30	–	–	V
Total Capacitance ( $V_R = 1.0\ \text{V}$ , $f = 1.0\ \text{MHz}$ )	$C_T$	–	7.6	10	pF
Reverse Leakage ( $V_R = 25\ \text{V}$ )	$I_R$	–	0.5	2.0	$\mu\text{A}$
Forward Voltage ( $I_F = 0.1\ \text{mA}$ )	$V_F$	–	0.22	0.24	V
Forward Voltage ( $I_F = 30\ \text{mA}$ )	$V_F$	–	0.41	0.5	V
Forward Voltage ( $I_F = 100\ \text{mA}$ )	$V_F$	–	0.52	0.8	V
Reverse Recovery Time ( $I_F = I_R = 10\ \text{mA}$ , $I_{R(REC)} = 1.0\ \text{mA}$ , Figure 1)	$t_{rr}$	–	–	5.0	ns
Forward Voltage ( $I_F = 1.0\ \text{mA}$ )	$V_F$	–	0.29	0.32	V
Forward Voltage ( $I_F = 10\ \text{mA}$ )	$V_F$	–	0.35	0.40	V
Forward Current (DC)	$I_F$	–	–	200	mA
Repetitive Peak Forward Current	$I_{FRM}$	–	–	300	mA
Non-Repetitive Peak Forward Current ( $t < 1.0\ \text{s}$ )	$I_{FSM}$	–	–	600	mA

## BAT54AWT1

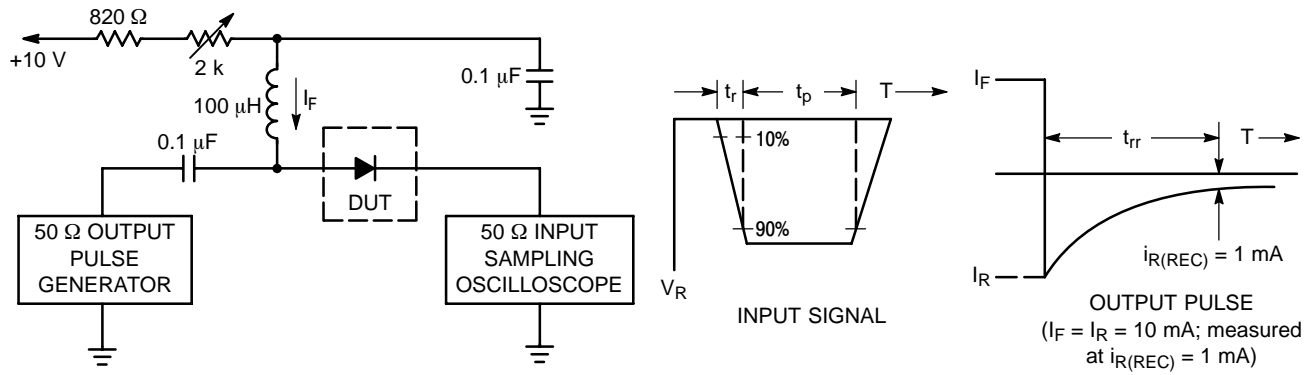


Figure 1. Recovery Time Equivalent Test Circuit

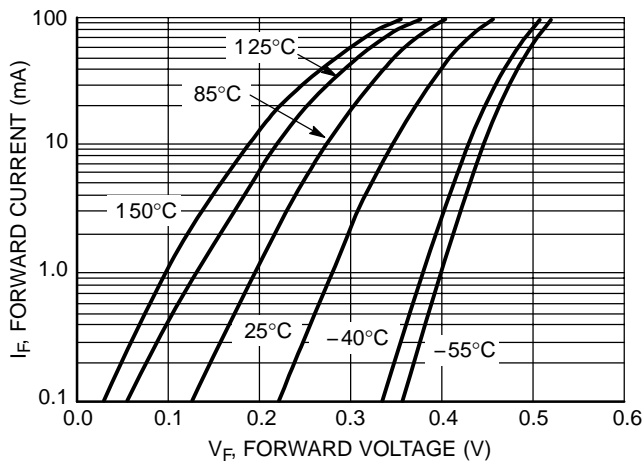


Figure 2. Forward Voltage

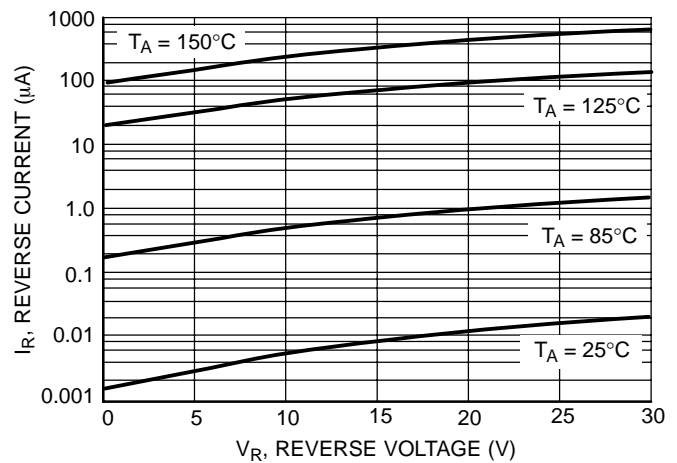


Figure 3. Leakage Current

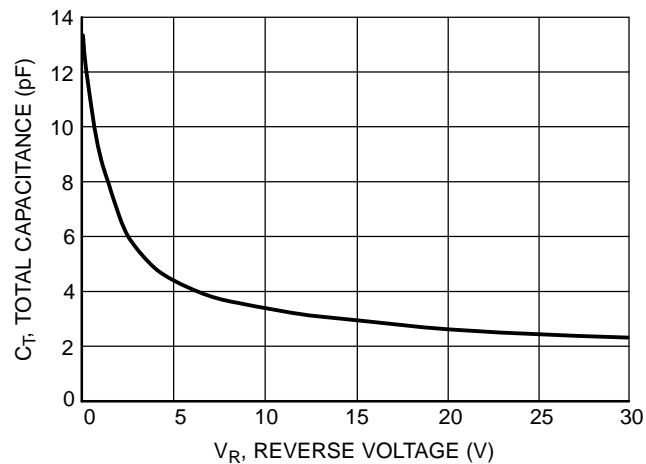


Figure 4. Total Capacitance

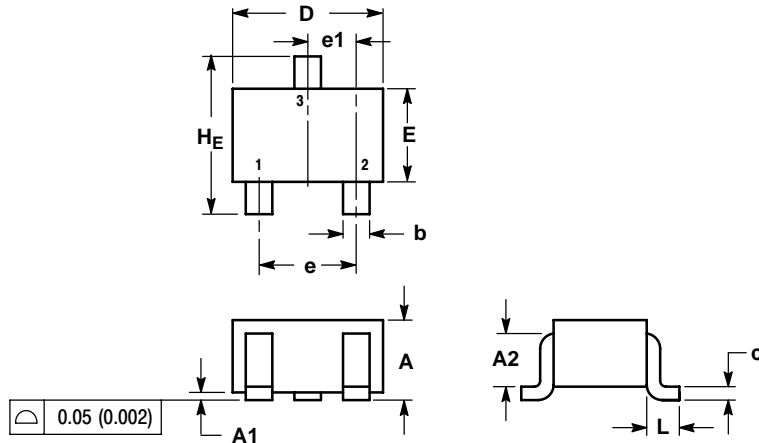
# BAT54AWT1

## PACKAGE DIMENSIONS

### SOT-323 (SC-70)

CASE 419-04

ISSUE M

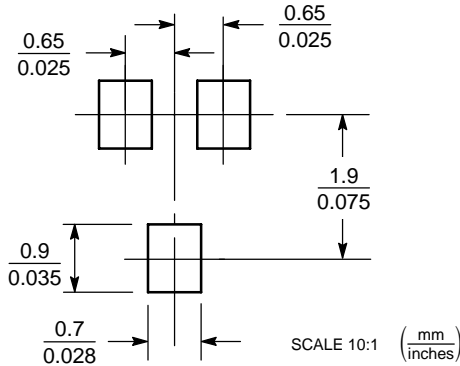


#### NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

DIM	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.80	0.90	1.00	0.032	0.035	0.040
A1	0.00	0.05	0.10	0.000	0.002	0.004
A2	0.7 REF			0.028 REF		
b	0.30	0.35	0.40	0.012	0.014	0.016
c	0.10	0.18	0.25	0.004	0.007	0.010
D	1.80	2.10	2.20	0.071	0.083	0.087
E	1.15	1.24	1.35	0.045	0.049	0.053
e	1.20	1.30	1.40	0.047	0.051	0.055
e1	0.65 BSC			0.026 BSC		
L	0.425 REF			0.017 REF		
H	2.00	2.10	2.40	0.079	0.083	0.095

### SOLDERING FOOTPRINT\*



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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